

Surface Mount RF Transformer

ADT4-6+

50Ω 0.07 to 250 MHz

Maximum Ratings

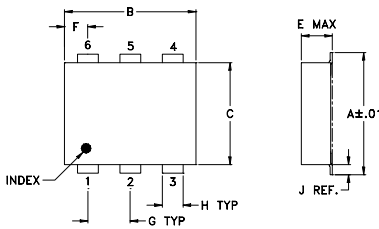
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.5W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

PRIMARY DOT	3
PRIMARY	1
SECONDARY DOT	4
SECONDARY	6
NOT USED	2,5

Outline Drawing



PCB Land Pattern



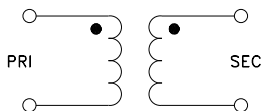
Suggested Layout,
Tolerance to be within ±.002

Outline Dimensions (inch)

A	B	C	D	E	F	G
.272	.310	.220	.100	.206	.055	.100
6.91	7.87	5.59	2.54	5.23	1.40	2.54
H	J	K	L	wt		
.030	.026	.065	.300	grams		
0.76	0.66	1.65	7.62	0.40		

Demo Board MCL P/N: TB-430

Config. C



Features

- excellent return loss, 21 dB typ. in 1 dB bandwidth
- aqueous washable
- protected under US patent 6,133,525

Applications

- impedance matching



Generic photo used for illustration purposes only

CASE STYLE: CD637

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Available Tape and Reel
at no extra cost

Reel Size	Devices/Reel
13"	900

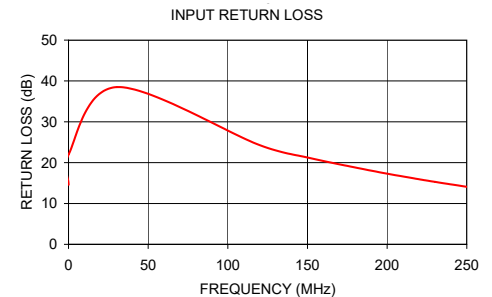
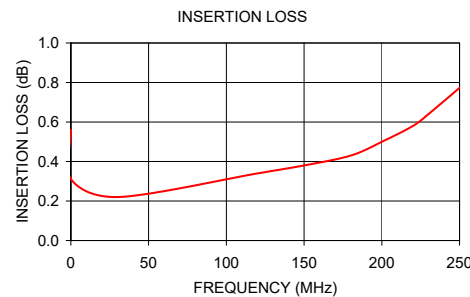
Transformer Electrical Specifications

Ω RATIO (Secondary/Primary)	FREQUENCY (MHz)	INSERTION LOSS*			PHASE UNBALANCE (Deg.) Typ.		AMPLITUDE UNBALANCE (dB) Typ.	
		3 dB MHz	2 dB MHz	1 dB MHz	1 dB bandwidth	2 dB bandwidth	1 dB bandwidth	2 dB bandwidth
4	0.07-250	0.07-250	0.1-220	0.15-150	-	-	0.2	0.5

* Insertion Loss is referenced to mid-band loss, 0.3 dB typ.

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
0.07	0.56	14.57	0.00	0.03
0.18	0.31	22.07	0.00	0.07
30.40	0.22	38.49	0.04	5.15
120.10	0.34	24.27	0.05	18.17
150.00	0.38	21.27	0.05	21.37
180.00	0.43	18.80	0.25	24.37
200.00	0.50	17.30	0.43	26.06
220.00	0.58	15.94	0.69	27.57
230.00	0.64	15.29	0.84	28.33
254.00	0.80	13.85	1.27	30.05



Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



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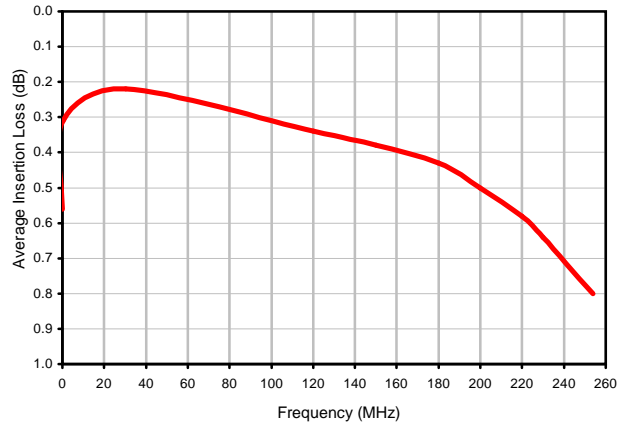
REV. F
M175723
ADT4-6+
ED-7964/1
WZ/TD/CP/AM
200421

Typical Performance Data

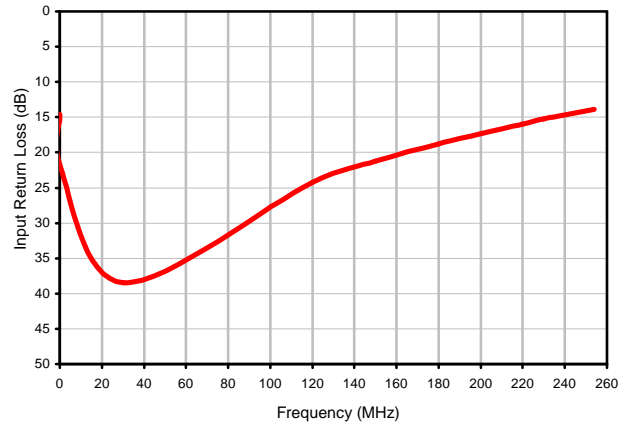
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg)
0.07	0.56	14.57	0.00	0.03
0.18	0.31	22.07	0.00	0.07
30.40	0.22	38.49	0.04	5.15
120.10	0.34	24.27	0.05	18.17
150.00	0.38	21.27	0.05	21.37
180.00	0.43	18.80	0.25	24.37
200.00	0.50	17.30	0.43	26.06
220.00	0.58	15.94	0.69	27.57
230.00	0.64	15.29	0.84	28.33
254.00	0.80	13.85	1.27	30.05

Typical Performance Curves

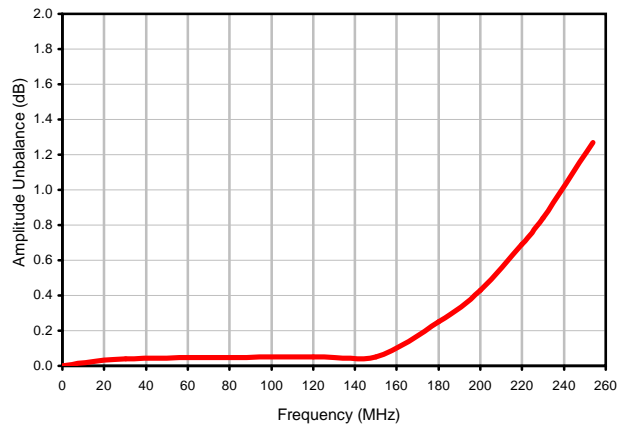
Average Insertion Loss



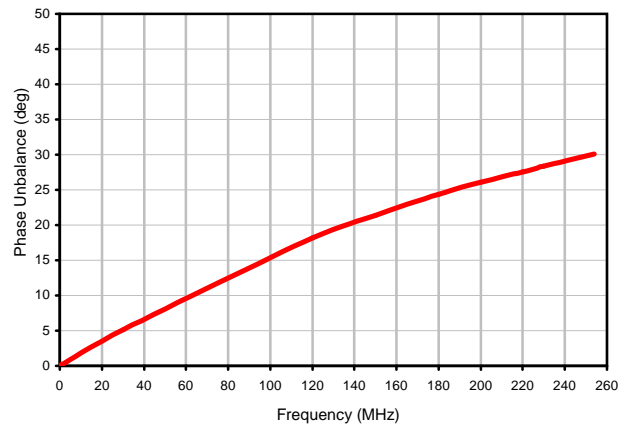
Input Return Loss



Amplitude Unbalance



Phase Unbalance



Case Style

CD

CD541
CD542
CD636
CD637

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE#	A	B	C	D	E	F	G	H	J	K	L	WT, GRAM
CD541					.082 (2.08)							.15
CD542	.272 (6.91)	.310 (7.87)	.220 (5.58)	.100 (2.54)	.112 (2.84)	.055 (1.40)	.100 (2.54)	.030 (0.76)	.026 (0.66)	.065 (1.65)	.300 (7.62)	.20
CD636					.162 (4.11)							.25
CD637					.206 (5.23)							.40

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
 - For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Mini-Circuits

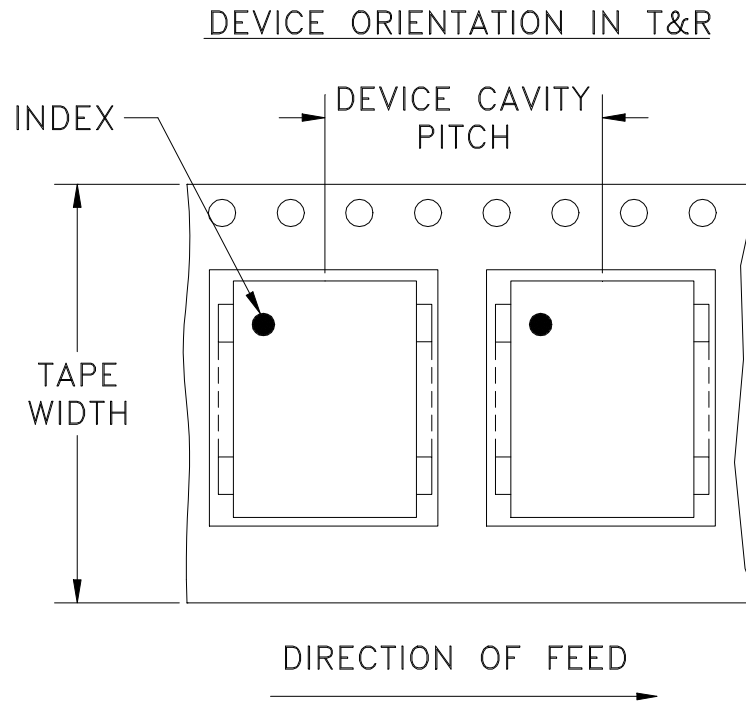
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Mini-Circuits ISO 9001 & ISO 14001 Certified

Tape & Reel Packaging TR-F46



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
16	12	13	900

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.
3. Must use ENA/PNA type agilent's network analyzers with impedance conversion option to convert ports to appropriate impedances.

 Mini-Circuits®

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215